

# TPC electronics Intro 2

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# What are we going to build in the end?

- Radial position: 30-85cm (Cage instrumented down to 20cm)
- Number of readout channels: ~200K
- ~40KV in the middle (400V/cm)
- Chevron type readout pads with approximately 1x10 mm<sup>2</sup> area each

- c.f. ALICE
  - Radial position: 85cm-2.5m
  - Longitudinal volume: 2\*2.5m
  - Drift voltage: 100KV (400V/cm)
  - Electronics: 560K channels

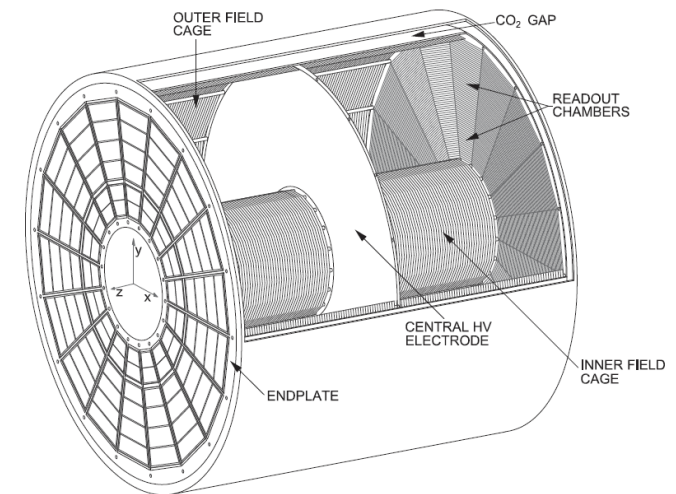
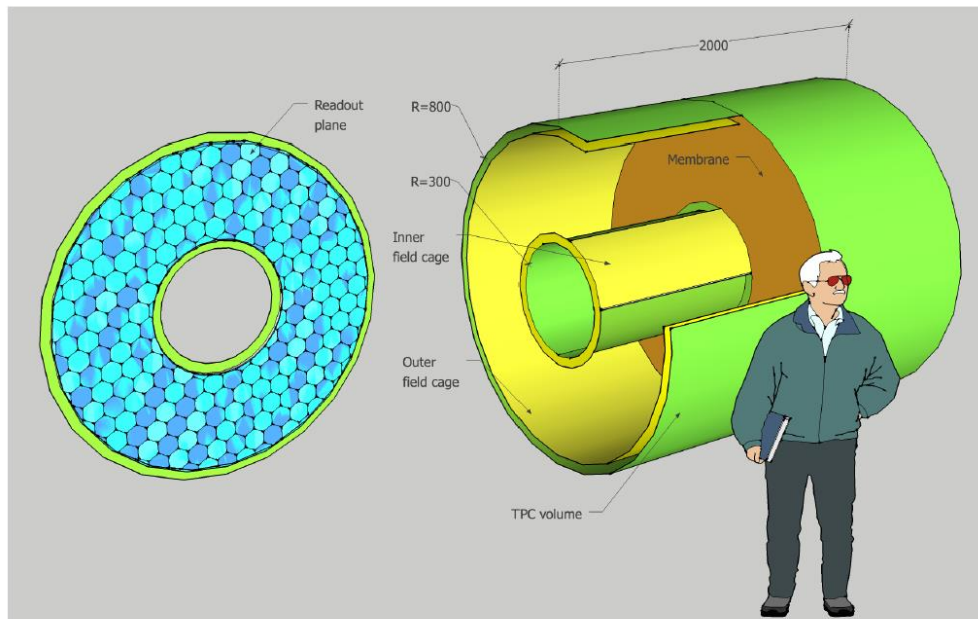


Figure 2.1: Schematic view of the ALICE TPC.

# Fund

- TPC development is now funded by BNL LDRD
  - Two year funding with ~\$150K/year. Considering contingency, it is effectively \$100K/year
- Already significantly used for field cage development, etc.
- We have some fund left for electronics development
  - Also, we can consider applying another fund.

# Readout situation

- We need electronics to readout. Based on the schedule outlined below, the electronics should be ready by the end of April next year
  - Roughly, one year from now
- We may want to establish a readout scheme that is also good for the final version if possible

Items	2015			2016												2017								
	10	11	12	1	2	3	4	5	6	7	8	9	10	11	12	1	2	3	4	5	6	7	8	9
Field Cage design					■	■	■	■																
Field Cage procurement							■		■	■	■	■	■											
Field Cage assembly							■							■	■	■	■	■	■					
GEM Blob production							■					■	■	■	■	■								
Chevron Pad ver1							■	■	■	■														
Chevron Pad ver2							■				■	■	■											
Chevron Pad ver3							■							■	■	■								
FEM Development							■	■	■	■	■	■	■	■	■	■	■	■	■					
Basic Performance test							■													■	■	■	■	
Beam Test							■																	■

FNAL Beam test

# We are now for STAR iTPC electronics

- Follow the current STAR's iTPC electronics development plan
- Schedule of SAMPA chips
  - The first non-packaged SAMPA chip should come out early June
  - A prototype testing board for the non-packaged chips is designed and will be manufactured by ALICE-affiliated French group by July.
    - Tonko will get one board for local STAR preliminary tests.
  - The packaged chip is expected in mid/late July at which point STAR will have their own board for further testing and other integration
- No formal design of the electronics exists at this moment
  - Cost estimate for 80K channels in the following slide.

# SAMPA chip in detail

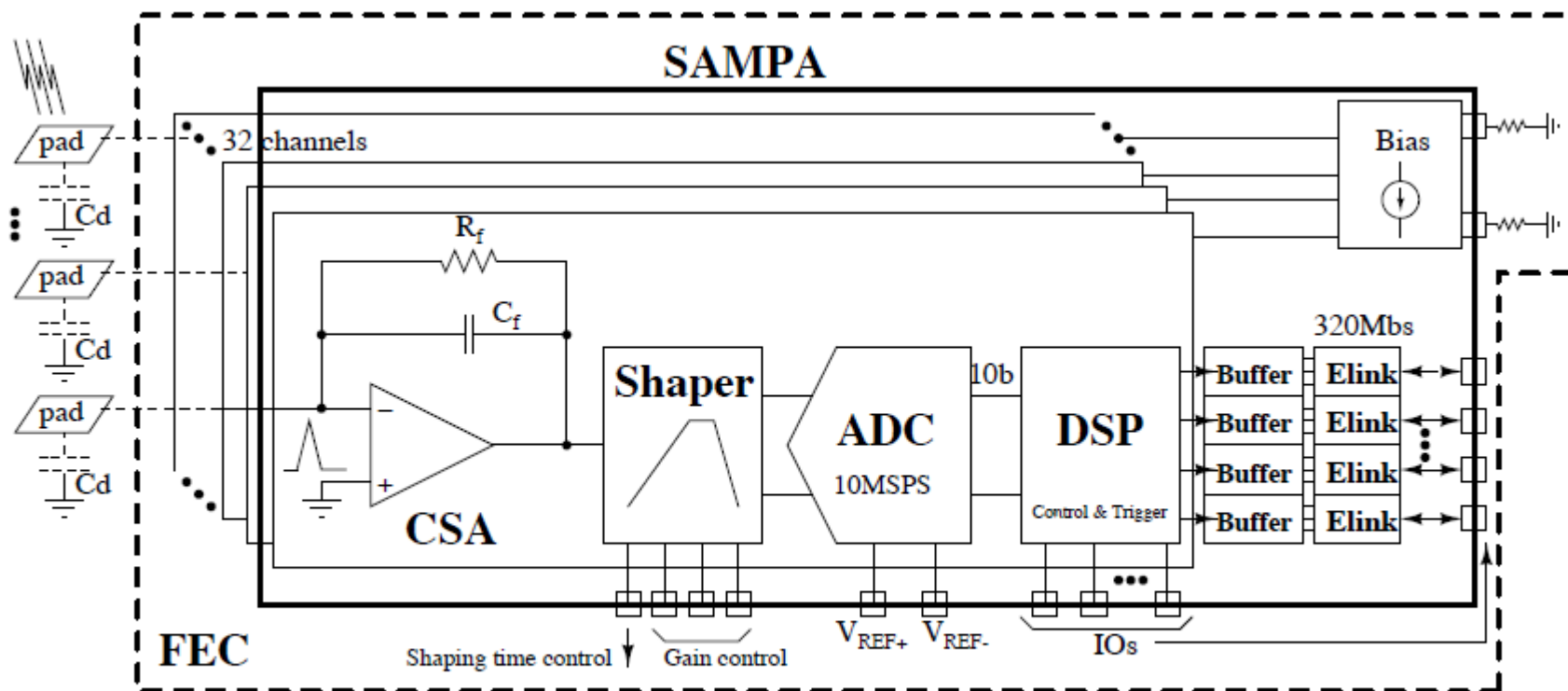
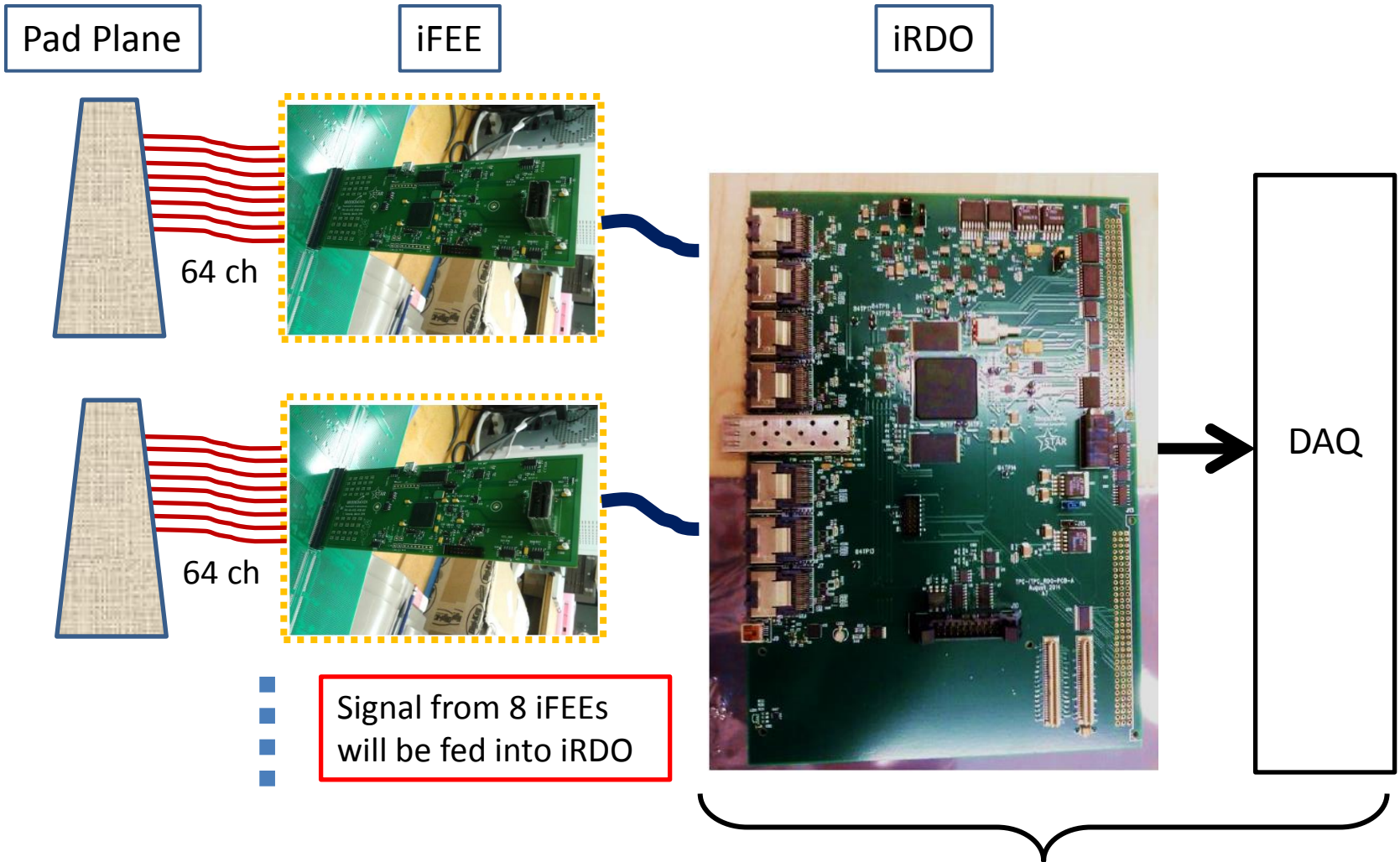


Figure 6.4: Schematic of the SAMPA ASIC for the GEM TPC readout, showing the main building blocks.

# Readout scheme



# Ref: Readout for ALICE TPC upgrade

- CRU interfaces the FEC and online computer farm
  - Our case, DCM-II will play the role of this.
  - FEC will send data in non-triggered mode, while DCM-II will send data in triggered mode
  - We may have to make a separate data collection stream for the TPC

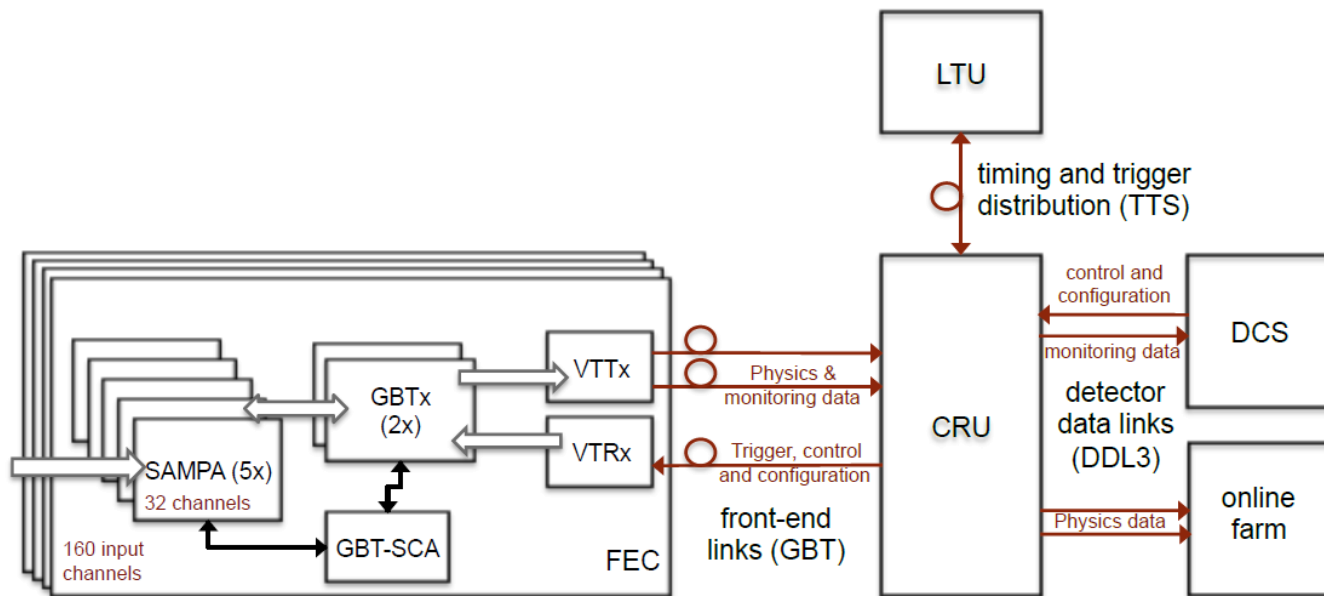


Figure 6.9: Schematic of the TPC readout system with the CRU as central part interfacing the front-end electronics to the trigger system, the DCS and the online farm.



# Data rate consideration

- ALICE case (based on TDR):
  - Average event size: 20Mbyte/s ( $dN/dy=8000$  for most central)
    - This number is no-pile up with shaping, sampling and zero-suppression
  - Number of pads: 560K
  - Interaction rate: 50KHz
  - Data rate:  $50\text{KHz} \times 20\text{Mbytes/s} = 1\text{Tbytes/s}$
- sPHENIX case:
  - Average event size: 7.5Mbytes/s ( $dN/dy=3000$  for most central)
  - Number of pads: 200K
  - Interaction rate: 25KHz
  - Data rate:  $25\text{KHz} \times 7.5\text{Mbytes/s} \times 0.4$  (scale by number of pads) =  $\sim 75\text{Gbytes/s}$

# From Tonko's slides (for 80K channels)

*We have to figure out the cost for labor!*

Presented in Jan, 2016

## Cost

	# items	# with spares	\$ per item	\$ all	With contingency (20%), overhead (56%)
SAMPA	2640	3500	\$44	\$154k	
iFEE	1320	1580	\$130 (wo SAMPA)	\$206k	
iRDO	96	116	\$1300	\$151k	
DAQ Receiver	24	26	\$3500	\$91k	
Cables, fibers, misc	-	-	-	\$50k	
Power Supplies	48	52	\$600	\$32k	
DAQ PC	24	26	\$3000	\$80k	
Totals				<b>\$764k</b>	<b>\$1430k</b>

# From Tonko's slides

*We could use the prototype iFEE for the current TPC development under BNL LDRD*

Presented in Jan, 2016

## Schedule

	2016	2017	2018 early	2018 late
padplane	prototype test produce		start sector installation	end sector installation
iFEE	evaluate SAMPA prototype with SAMPA	final version produce 1 sector's worth	produce all PCBs vet PCB purchase all components install into 1 sector & test	SAMPA arrives mount SAMPA & components Q&A install all full system test
iRDO	prototype 2	final version produce 1 sector's worth	produce & Q&A all install into 1 sector & test	install all full system test
Power Supplies Trigger Cables Fibers	evaluate	evaluate test	purchase & install all full test using 1 sector's worth	full system test
Receiver Cards	prototype test	final version	purchase & install all full test using 1 sector's worth	full system test
DAQ PCs	develop drivers	final drivers & software... specification	purchase & install all full test using 1 sector's worth	full system test

# Backup

# sPHENIX TPC FEC cost (Nov. 2015)

Test Stand Modification	30	\$8,000.00	TPC-E-2180
Assemble and test prototype electronics: preproduction prototype	20	\$3,000.00	TPC-E-2230
Review and write design change specifications	25	\$43,000.00	TPC-E-2260

## 1.3.4.10.1.3

BOE prepared

Items	Duration (d)	costs	Notes
Final external design review	20	\$33,000.00	TPC-E-3120
Procure all components needed for TPC FEC production	20	\$750,000.00	TPC-E-1180, labor not included
purchase a power supply module	5	\$84,000.00	Just to order, labor not included
Fabricate and assemble TPC FEC: production	55	\$220,000.00	TPC-E-2180
Test and qualify TPC FEC production	55	\$40,000.00	TPC-E-1230

## Not listed in the WBS

Items	Duration (d)	costs	Notes
Shipping fee (to ORNL)	10	\$600.00	TPC-E-1190
Proess University of Houston Subcontract fee	1	\$6,900.00	TPC-E-1180
Final Vendor Evaluation and Selection	70	\$22,000.00	TPC-E-3110
FY16, Mgmt coord, contributed LOE and Travel	270	\$49,000.00	TPC-TR-FY16
FY17, Mgmt coord, contributed LOE and Travel	250	\$42,000.00	TPC-TR-FY17
FY18, Mgmt coord, contributed LOE and Travel	200	\$43,000.00	TPC-TR-FY18

**Total**

Total Time (days, listed in WBS)

750

\*Not accounting for any parallel job splitting

Total Costs

\$1,869,500.00

Additional Costs for labor

\$561,600.00

\* used 8hrs/day, \$120/hr

\* labor days: 750 - 165 (parts procurement and fabrication) = 585 days

\* maybe double counting the labor cost for design/layout (corresponding to \$270,000.00)

\*\*\* The number in notes are the pointer to the ALICE TPC electronics WBS

\*\*\* For actual material costs related to fabrication of boards, I scaled the costs by the factor of 2.5; We assume 200K channels, while ALICE TPC upgrade, it is 550K channels.  
550/200=2.75, so 2.5 is a conservative estimate of the cost of fabrication

Almost complete copy of ALICE WBS scaled by the # channels (560K -> 200K)

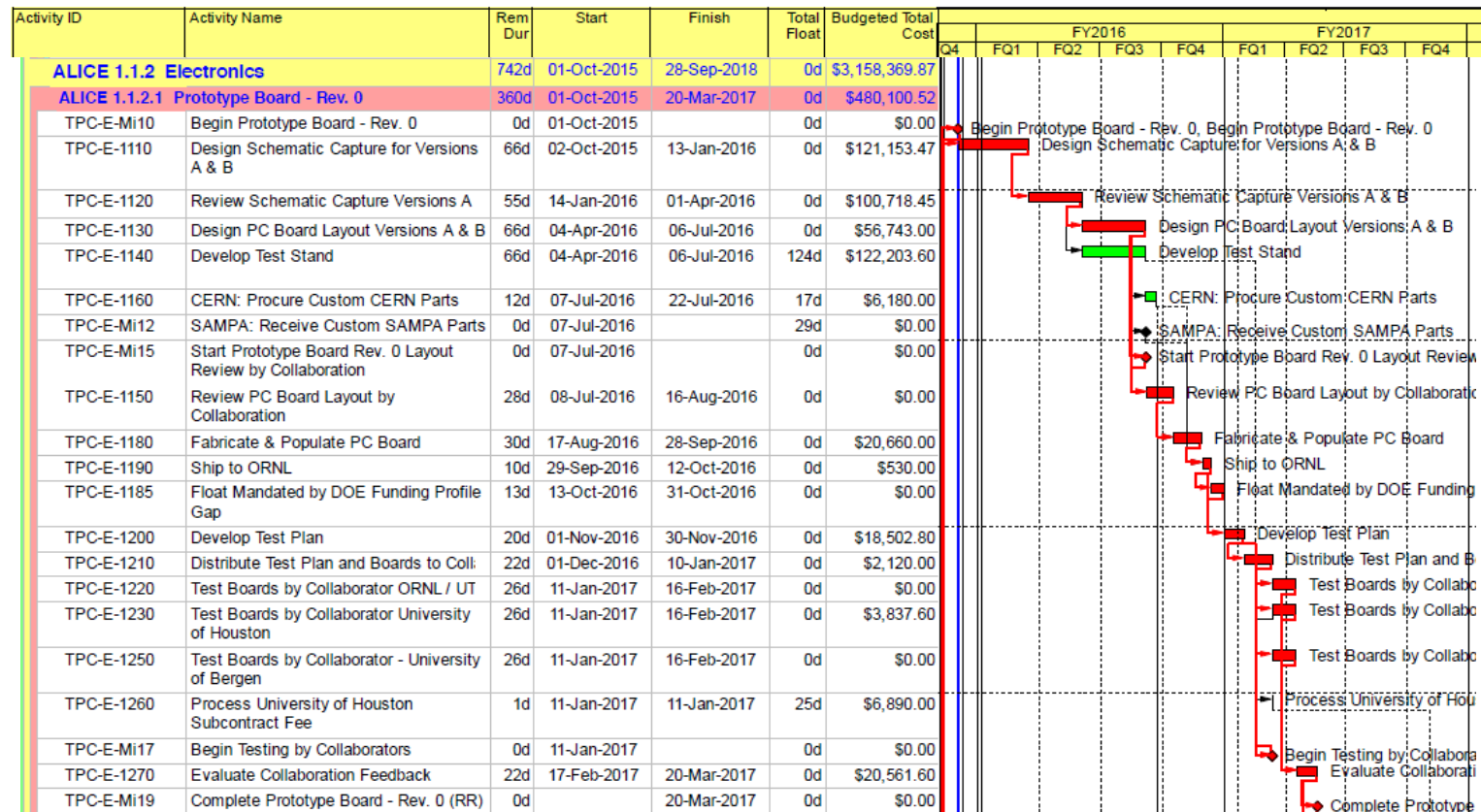
6/3/2016

# Cost and Schedule consideration

- Based on ALICE upgrade TPC electronics WBS
  - Details are in ORNL's WBS in the backup
- ALICE case: Two prototypes: Rev0 and Rev1
  - Takes three years to complete
  - Basically, board design and layout
- sPHENIX case: prototype-1 and pre-production prototype
  - Should take three years or less to complete
  - Pre-production prototype can be used for performance evaluation of TPC detector itself
- Cost partly depends on the number of channels
  - Material cost for the final production is reduced proportionally by the number of channels compare to ALICE TPC case
  - Detail evaluation of labor and material costs ended up with ~\$2.5M for the sPHENIX case
  - Details follow from the next slide

# ALICE schedule from WBS last year

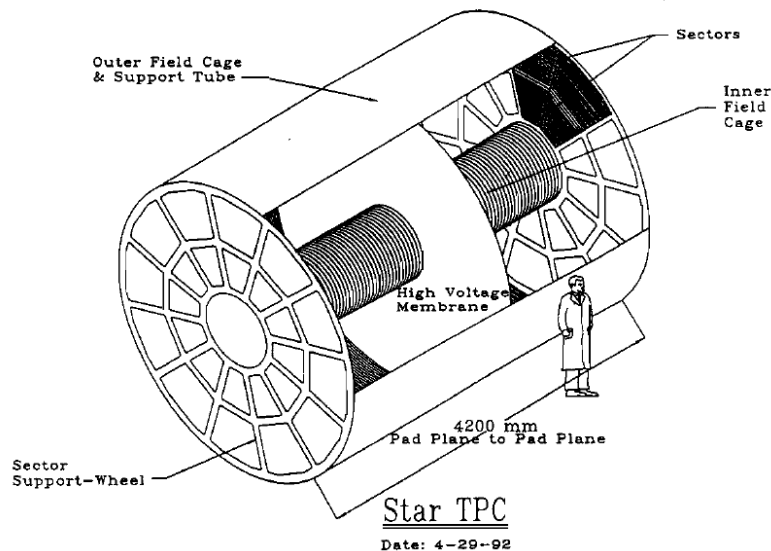
- The very first version of proto-type will be produced by the end of FY16
  - I thought they will produce ~10% of total. I should check
- One option is to join the test board effort?



# How sPHENIX TPC is compared with others?

- STAR

- Radial position: 60cm-1.9m
- Longitudinal volume: 2\*2.1m
- Drift voltage: 28kV (135V/cm)
- Electronics: 140K channels
- $dN/dy$ : 3000



- ALICE

- Radial position: 85cm-2.5m
- Longitudinal volume: 2\*2.5m
- Drift voltage: 100KV (400V/cm)
- Electronics: 560K channels
- $dN/dy$ : 8000 (40% occupancy at the inner radius)

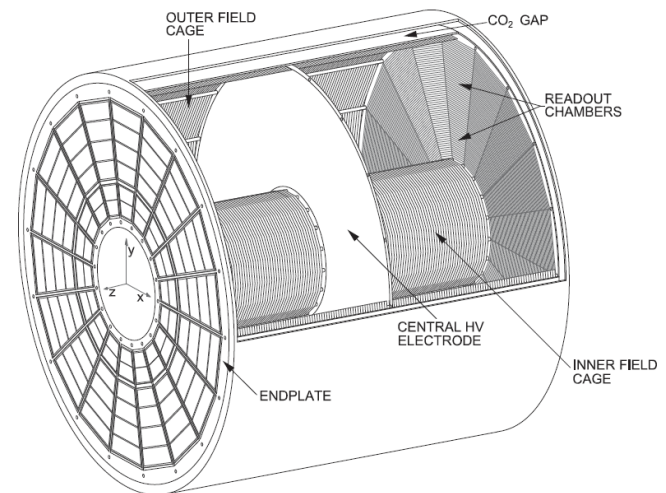


Figure 2.1: Schematic view of the ALICE TPC.

sPHENIX TPC is around half scale downsize of these TPCs!